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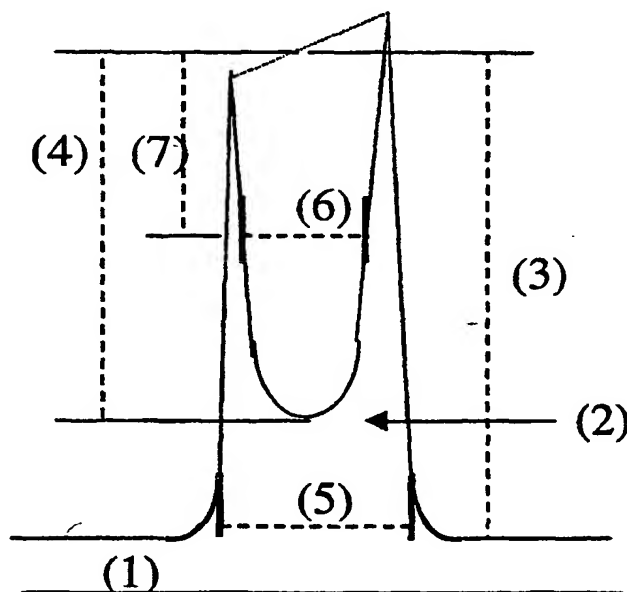
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(54) Title: FRINGED SURFACE STRUCTURES OBTAINABLE IN A COMPRESSION MOLDING PROCESS

(57) Abstract: Disclosed are mono-layer or  
multi-layer films, sheets, or coatings wherein  
at least one layer comprises a fringed surface  
microstructure (1), a process for making these  
items and uses thereof. Further disclosed are  
articles of manufacture comprising such film,  
sheet, or coating.

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